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TRANSM	IITTAL	Filing Dafe	December 8, 2003			
FOR	RM	First Named Inventor	Brown et al.			
(to be used for all correspon	ndence after initial filing)	Art Unit	Not Yet Known			
(1000 000 000 000 000 000	,,	Examiner Name	Not Yet Known			
		Attorney Docket Number				
Total Number of Pages in Th	nis Submission		EPC-00007			
	ENCL	OSURES (Check all that	t apply)			
Fee Attached Licensing-related Papers of Appeals and Interferences Appeal Communication to TC			to Technology Center (TC) Appeal Communication to Board of Appeals and Interferences Appeal Communication to TC (Appeal Notice, Brief, Reply Brief) Proprietary Information Status Letter Other Enclosure(s) (please Identify below): Form PTO-1449 and 9			
under 37 CF	R 1.52 or 1.53					
	SIGNATURE O	F APPLICANT, ATTORNI	EY, OR AGENT			
Firm Randolp	oh J. Huis	Re	g. No. 34,626			
or Individual name Volpe a	ng Koenig PC.		R. State			
Signature (Quality)						
Date 5/12/2004						
CERTIFICATE OF TRANSMISSION/MAILING						
I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown below. Typed or printed name Randolph J. Hujs						
Signature Date 5/12/2004						
This collection of information is required by 37 CFR 1.5. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to						

process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to 2 hours to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the **PATENT APPLICATION** of:

Brown et al.

Application No.: 10/731,669

Confirmation No.: Not Yet Known

Filed: De

December 8, 2003

For: A CONNECTOR FOR MAKING

ELECTRICAL CONTACT AT SEMICONDUCTOR SCALES

Group:

Not Yet Known

Examiner:

Not Yet Known

Our File: EPC-00007

Date: May 12, 2004

INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Further to Applicants' Duty of Disclosure pursuant to 37 C.F.R. §1.56, Applicants wish to bring to the Examiner's attention the material cited on the enclosed PTO-1449 form. Pursuant to Pre-Official Gazette Notice signed July 11, 2003 waiving the requirements under 37 C.F.R. § 1.98(a)(2)(i) for applications filed after June 30, 2003, copies of the cited U.S. documents have not been included. Copies of all other cited references are enclosed.

Only abstracts of Japanese publications 2000011443 and 2001203435 are provided.

Applicant: Brown et al. Application No.: 10/731,669

Some of these documents were cited in at least one of the Office Actions dated December 29, 2003, April 9, 2004 and April 12, 2004 that were issued in co-pending applications 10/460,496, 10/460,501 and 10/460,504, each filed on June 11, 2003.

To the best knowledge of the undersigned, this Information Disclosure Statement is being submitted prior to a first Office Action on the merits. Accordingly, no fee is required.

It is respectfully requested that the Examiner consider these documents and return an initialed copy of the PTO-1449 form indicating his consideration of the cited materials.

Respectfully submitted,

Brown et al.

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Registration No. 34,626

(215) 568-6400

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FORM PTO-1449 U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE INFORMATION DISCLOSURE STATEMENT BY APPLICANT

ATTY. DOCKET NO. EPC-00007

SERIAL NO. 10/731,669

APPLICANT Brown et al.

FILING DATE December 8, 2003 GROUP Not Yet Known

(Use several sheets if necessary)

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